# **Dual General Purpose Transistor**

The NST3904DP6T5G device is a spin-off of our popular SOT-23/SOT-323/SOT-563 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-963 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

## **Features**

- h<sub>FE</sub>, 100-300
- Low  $V_{CE(sat)}$ ,  $\leq 0.4 \text{ V}$
- Reduces Board Space and Component Count
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

### **MAXIMUM RATINGS**

| Rating                         |           | Symbol           | Value  | Unit |
|--------------------------------|-----------|------------------|--------|------|
| Collector - Emitter Voltage    |           | $V_{CEO}$        | 40     | Vdc  |
| Collector - Base Voltage       |           | V <sub>CBO</sub> | 60     | Vdc  |
| Emitter – Base Voltage         |           | V <sub>EBO</sub> | 6.0    | Vdc  |
| Collector Current - Continuous |           | I <sub>C</sub>   | 200    | mAdc |
| Electrostatic Discharge        | HBM<br>MM | ESD<br>Class     | 2<br>B |      |

## THERMAL CHARACTERISTICS

| Characteristic (Single Heated)  | Symbol            | Max        | Unit        |
|---|-------------------|------------|-------------|
| Characteristic (Single Heated)  | Syllibol          | IVIAX      | Ollit       |
| Total Device Dissipation T <sub>A</sub> = 25°C  | $P_{D}$           | 240        | mW          |
| Derate above 25°C (Note 1)  |                   | 1.9        | mW/°C       |
| Thermal Resistance, Junction-to-Ambient   | $R_{\theta JA}$   | 520        | °C/W        |
| (Note 1)  |                   |            |             |
| Total Device Dissipation T <sub>A</sub> = 25°C  | $P_{D}$           | 280        | mW          |
| Derate above 25°C (Note 2)  |                   | 2.2        | mW/°C       |
| Thermal Resistance, Junction-to-Ambient   | $R_{\theta JA}$   | 446        | °C/W        |
| (Note 2)  | 00/1              |            |             |
| Characteristic (Dual Heated) (Note 3)   | Symbol            | Max        | Unit        |
| Total Device Dissipation T <sub>A</sub> = 25°C  | $P_{D}$           | 350        | mW          |
| Derate above 25°C (Note 1)  |                   | 2.8        | mW/°C       |
| Thermal Resistance, Junction-to-Ambient   | R <sub>0.IA</sub> | 057        |             |
|   |                   | 357        | °C/W        |
| (Note 1)  | ιθJΑ              | 357        | °C/W        |
| ,   | 00,1              | 420        | °C/W<br>mW  |
| (Note 1)  Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C (Note 2)                               | P <sub>D</sub>    |            | ,           |
| Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C (Note 2)   | P <sub>D</sub>    | 420        | mW          |
| Total Device Dissipation T <sub>A</sub> = 25°C  | 00,1              | 420<br>3.4 | mW<br>mW/°C |
| Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C (Note 2) Thermal Resistance, Junction-to-Ambient | P <sub>D</sub>    | 420<br>3.4 | mW<br>mW/°C |

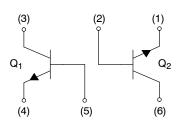
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. FR-4 @ 100 mm<sup>2</sup>, 1 oz. copper traces, still air. 2. FR-4 @ 500 mm<sup>2</sup>, 1 oz. copper traces, still air.
- 3. Dual heated values assume total power is sum of two equally powered channels.



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NST3904DP6T5G



SOT-963 CASE 527AD

## MARKING DIAGRAM



= Device Code = Date Code

## **ORDERING INFORMATION**

| Device         | Package              | Shipping <sup>†</sup> |
|----------------|----------------------|-----------------------|
| NST3904DP6T5G  | SOT-963<br>(Pb-Free) | 8000/Tape & Reel      |
| NSVT3904DP6T5G | SOT-963<br>(Pb-Free) | 8000/Tape & Reel      |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25$ °C unless otherwise noted)

|  | ,   |                      |                             | 1                  |      |  |
|--|---|----------------------|-----------------------------|--------------------|------|--|
| Characteristic   |   | Symbol               | Min                         | Max                | Unit |  |
| OFF CHARACTERISTICS  |   |                      |                             |                    |      |  |
| Collector – Emitter Breakdown Voltage (Note 4) (I <sub>C</sub> = 1.0 mAdc, I <sub>B</sub> = 0)   |   | V <sub>(BR)CEO</sub> | 40                          | -                  | Vdc  |  |
| Collector – Base Breakdown Voltage (I <sub>C</sub> = 10 μAdc, I <sub>E</sub> = 0)  |   | V <sub>(BR)CBO</sub> | 60                          | -                  | Vdc  |  |
| Emitter – Base Breakdown Voltage ( $I_E = 10 \mu Adc, I_C = 0$ )   |   | V <sub>(BR)EBO</sub> | 6.0                         | -                  | Vdc  |  |
| Collector Cutoff Current (V <sub>CE</sub> = 30 Vdc, V <sub>EB</sub> = 3.0 Vdc)   |   | I <sub>CEX</sub>     | -                           | 50                 | nAdc |  |
| ON CHARACTERISTICS (Note 4)  |   |                      |                             |                    |      |  |
| DC Current Gain $ \begin{aligned} &\text{(I_C = 0.1 mAdc, V_{CE} = 1.0 Vdc)} \\ &\text{(I_C = 1.0 mAdc, V_{CE} = 1.0 Vdc)} \\ &\text{(I_C = 10 mAdc, V_{CE} = 1.0 Vdc)} \\ &\text{(I_C = 50 mAdc, V_{CE} = 1.0 Vdc)} \\ &\text{(I_C = 100 mAdc, V_{CE} = 1.0 Vdc)} \end{aligned} $ |   | h <sub>FE</sub>      | 40<br>70<br>100<br>60<br>30 | -<br>300<br>-<br>- | -    |  |
| Collector – Emitter Saturation Voltage (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 1.0 mAdc) (I <sub>C</sub> = 50 mAdc, I <sub>B</sub> = 5.0 mAdc)   |   | V <sub>CE(sat)</sub> | -<br>-                      | 0.2<br>0.3         | Vdc  |  |
| Base – Emitter Saturation Voltage (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 1.0 mAdc) (I <sub>C</sub> = 50 mAdc, I <sub>B</sub> = 5.0 mAdc)  |   | V <sub>BE(sat)</sub> | 0.65<br>-                   | 0.85<br>0.95       | Vdc  |  |
| SMALL-SIGNAL CHARACTERIS   | STICS   |                      |                             |                    | •    |  |
| Current – Gain – Bandwidth Product (I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 20 Vdc, f = 100 MHz)   |   | f <sub>T</sub>       | 200                         | -                  | MHz  |  |
| Output Capacitance (V <sub>CB</sub> = 5.0 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)  |   | C <sub>obo</sub>     | -                           | 4.0                | pF   |  |
| Input Capacitance (V <sub>EB</sub> = 0.5 Vdc, I <sub>C</sub> = 0, f = 1.0 MHz)   |   | C <sub>ibo</sub>     | -                           | 8.0                | pF   |  |
| Noise Figure ( $V_{CE}$ = 5.0 Vdc, $I_{C}$ = 100 $\mu$ Adc, $R_{S}$ = 1.0 k $\Omega$ , f = 1.0 kHz)  |   | NF                   | -                           | 5.0                | dB   |  |
| SWITCHING CHARACTERISTICS  | 3   |                      | •                           | •                  | •    |  |
| Delay Time   | $(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc})$ | t <sub>d</sub>       | _                           | 35                 |      |  |
| Rise Time  | (I <sub>C</sub> = 10 mAdc, I <sub>B1</sub> = 1.0 mAdc)  | t <sub>r</sub>       | _                           | 35                 | ns   |  |
| Storage Time   | $(V_{CC} = 3.0 \text{ Vdc}, I_C = 10 \text{ mAdc})$     | t <sub>s</sub>       | _                           | 275                |      |  |
| Fall Time  | $(I_{B1} = I_{B2} = 1.0 \text{ mAdc})$                  | t <sub>f</sub>       | _                           | 50                 | ns   |  |

<sup>4.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s; Duty Cycle  $\leq$  2.0%.

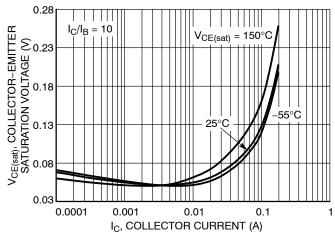


Figure 1. Collector Emitter Saturation Voltage vs.
Collector Current

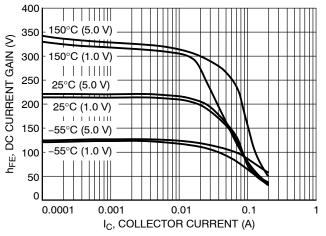


Figure 2. DC Current Gain vs. Collector Current

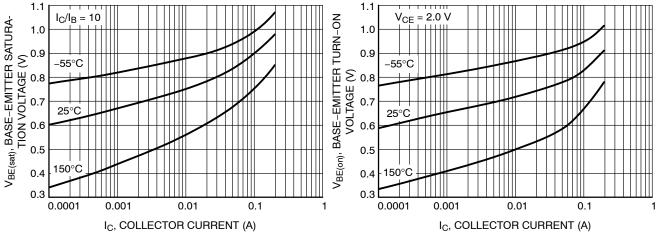
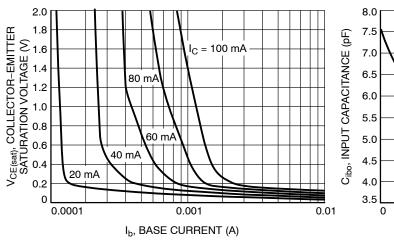


Figure 3. Base Emitter Saturation Voltage vs. Collector Current

Figure 4. Base Emitter Turn-On Voltage vs.
Collector Current



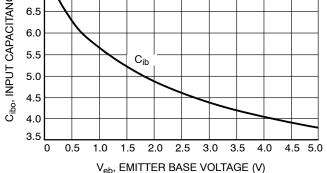


Figure 5. Saturation Region

Figure 6. Input Capacitance

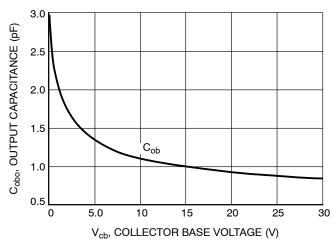
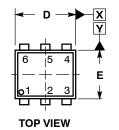
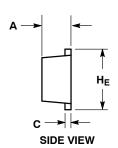


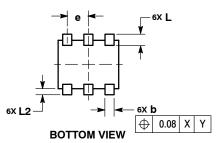
Figure 7. Output Capacitance

#### PACKAGE DIMENSIONS

SOT-963 CASE 527AD **ISSUE E** 





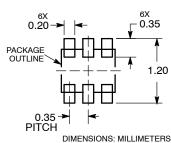


#### NOTES

- DIMENSIONING AND TOLERANCING PER ASME
- Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

|     | MILLIMETERS |      |      |  |
|-----|-------------|------|------|--|
| DIM | MIN         | NOM  | MAX  |  |
| Α   | 0.34        | 0.37 | 0.40 |  |
| b   | 0.10        | 0.15 | 0.20 |  |
| С   | 0.07        | 0.12 | 0.17 |  |
| D   | 0.95        | 1.00 | 1.05 |  |
| E   | 0.75        | 0.80 | 0.85 |  |
| е   | 0.35 BSC    |      |      |  |
| HE  | 0.95        | 1.00 | 1.05 |  |
| L   | 0.19 REF    |      |      |  |
| L2  | 0.05        | 0.10 | 0.15 |  |

#### **RECOMMENDED MOUNTING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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